OSRAM LW TTSD

Datasheet

Published by ams-OSRAM AG
Tobelbader Strasse 30, 8141 Premstaetten, Austria
Phone +43 3136 500-0
ams-osram.com

TOPLED®

LW TTSD binning FK0PN0

TOPLED, SMT LED with integrated reflector. With our great experience in SMT LED we are able to offer a high quality product for all kind of applications.

Applications

- Ambient Lighting
- Appliances & Tools
- Automotive Aftermarket

Features

- Package: white PLCC-2 package, colored diffused silicone resin
- Chip technology: ThinGaN
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.33, Cy = 0.33 acc. to CIE 1931 (● white)
- Corrosion Robustness Class: 3B
- Qualifications: AEC-Q102 Qualified
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)

Ordering Information

Type	Luminous Intensity [1] I_F = 20 mA I_v	Mounting methode	Ordering Code
LW TTSD-U1V2-FK0PN0-35	450 ... 1120 mcd	Top	Q65113A0873

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min. max.	-40 °C 110 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 110 °C
Junction Temperature	T_j	max.	125 °C
Forward current T_S = 25 °C	I_F	min. max.	1 mA 30 mA
Surge current t ≤ 10 µs; D = 0.005 ; T_S = 25 °C	I_{FS}	max.	200 mA
Reverse voltage [2)] T_S = 25 °C	V_R	max.	5 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM)	V_{ESD}		2 kV

Characteristics

I_F = 20 mA; T_S = 25 °C

Parameter	Symbol		Values
Chromaticity Coordinate [3]	Cx	typ.	0.33
	Cy	typ.	0.33
Viewing angle at 50% I_V	2φ	typ.	120 °
Forward Voltage [4]	V_F	min.	2.60 V
I_F = 20 mA		typ.	3.00 V
		max.	3.50 V
Reverse current [2]	I_R	typ.	0.01 µA
V_R = 5 V		max.	10 µA
Real thermal resistance junction/ambient [5][6]	$R_{thJA\ real}$	max.	340 K / W
Real thermal resistance junction/solderpoint [5]	$R_{thJS\ real}$	max.	180 K / W

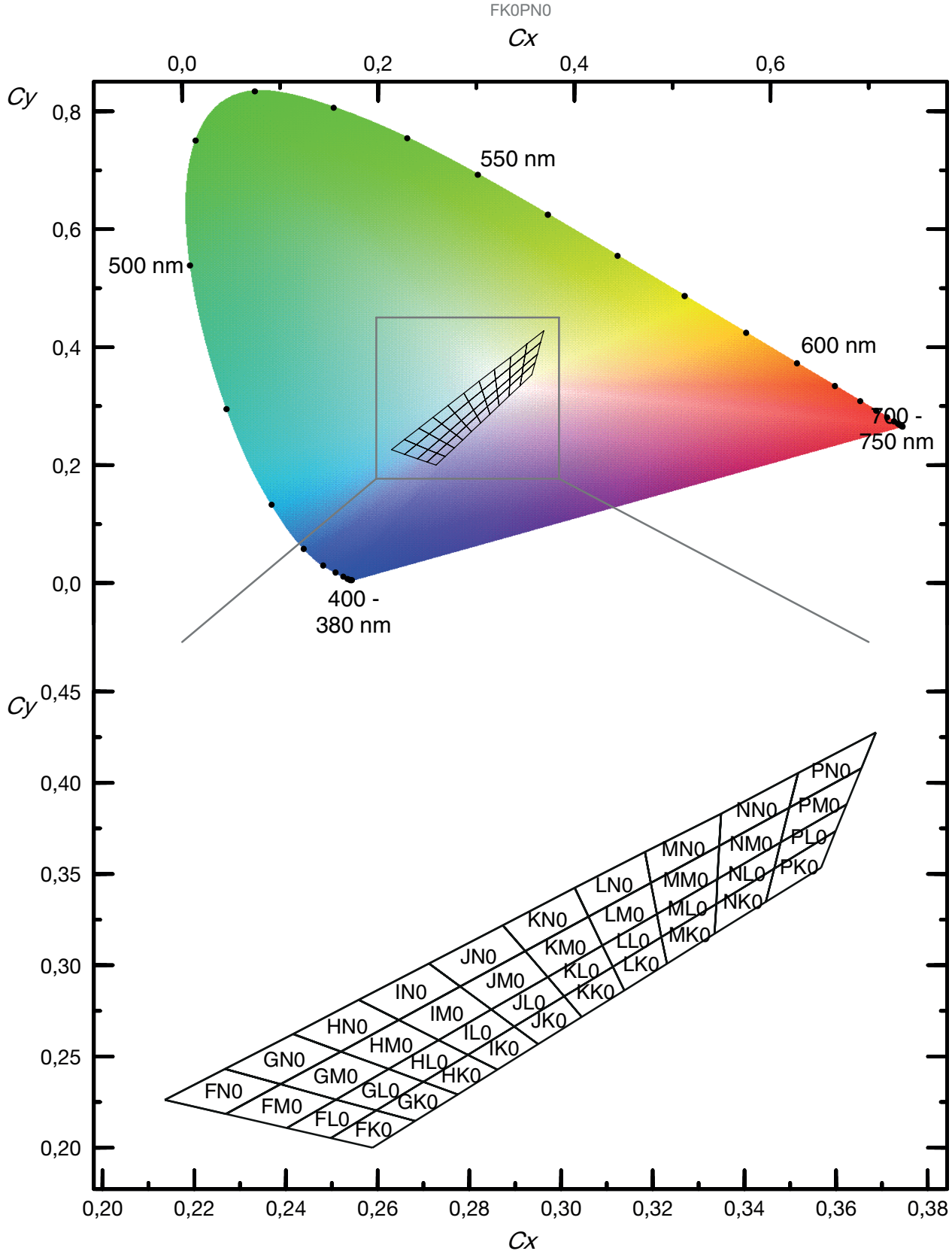
Brightness Groups

Group	Luminous Intensity [1] I_F = 20 mA min. I_v	Luminous Intensity [1] I_F = 20 mA max. I_v	Luminous Flux [7] I_F = 20 mA typ. Φ_V
U1	450 mcd	560 mcd	1515 mlm
U2	560 mcd	710 mcd	1905 mlm
V1	710 mcd	900 mcd	2415 mlm
V2	900 mcd	1120 mcd	3030 mlm

Forward Voltage Groups

Group	Forward Voltage [4] I_F = 20 mA min. V_F	Forward Voltage [4] I_F = 20 mA max. V_F
3	2.60 V	2.90 V
4	2.90 V	3.20 V
5	3.20 V	3.50 V

Chromaticity Coordinate Groups



Chromaticity Coordinate Groups [3)]

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
FK0	0.2498	0.2053	HK0	0.2700	0.2361	JK0	0.2898	0.2664
	0.2597	0.2204		0.2797	0.2509		0.3007	0.2830
	0.2682	0.2146		0.2861	0.2427		0.3045	0.2717
	0.2589	0.2000		0.2775	0.2292		0.2950	0.2568
FL0	0.2402	0.2108	HL0	0.2624	0.2431	JL0	0.2848	0.2757
	0.2509	0.2264		0.2733	0.2590		0.2971	0.2935
	0.2597	0.2204		0.2797	0.2509		0.3007	0.2830
	0.2498	0.2053		0.2700	0.2361		0.2898	0.2664
FM0	0.2269	0.2185	HM0	0.2520	0.2527	JM0	0.2780	0.2883
	0.2388	0.2348		0.2646	0.2700		0.2922	0.3077
	0.2509	0.2264		0.2733	0.2590		0.2971	0.2935
	0.2402	0.2108		0.2624	0.2431		0.2848	0.2757
FN0	0.2136	0.2262	HN0	0.2416	0.2623	JN0	0.2712	0.3009
	0.2267	0.2432		0.2559	0.2810		0.2873	0.3219
	0.2388	0.2348		0.2646	0.2700		0.2922	0.3077
	0.2269	0.2185		0.2520	0.2527		0.2780	0.2883
GK0	0.2597	0.2204	IK0	0.2797	0.2509	KK0	0.3007	0.2830
	0.2700	0.2361		0.2898	0.2664		0.3113	0.2992
	0.2775	0.2292		0.2950	0.2568		0.3138	0.2862
	0.2682	0.2146		0.2861	0.2427		0.3045	0.2717
GL0	0.2509	0.2264	IL0	0.2733	0.2590	KL0	0.2971	0.2935
	0.2624	0.2431		0.2848	0.2757		0.3090	0.3108
	0.2700	0.2361		0.2898	0.2664		0.3113	0.2992
	0.2597	0.2204		0.2797	0.2509		0.3007	0.2830
GM0	0.2388	0.2348	IM0	0.2646	0.2700	KM0	0.2922	0.3077
	0.2520	0.2527		0.2780	0.2883		0.3060	0.3266
	0.2624	0.2431		0.2848	0.2757		0.3090	0.3108
	0.2509	0.2264		0.2733	0.2590		0.2971	0.2935
GN0	0.2267	0.2432	IN0	0.2559	0.2810	KN0	0.2873	0.3219
	0.2416	0.2623		0.2712	0.3009		0.3030	0.3424
	0.2520	0.2527		0.2780	0.2883		0.3060	0.3266
	0.2388	0.2348		0.2646	0.2700		0.2922	0.3077

Group	Cx	Cy
LK0	0.3113	0.2992
	0.3219	0.3154
	0.3231	0.3008
	0.3138	0.2862
LL0	0.3090	0.3108
	0.3209	0.3281
	0.3219	0.3154
	0.3113	0.2992
LM0	0.3060	0.3266
	0.3196	0.3451
	0.3209	0.3281
	0.3090	0.3108
LN0	0.3030	0.3424
	0.3183	0.3621
	0.3196	0.3451
	0.3060	0.3266
MK0	0.3219	0.3154
	0.3339	0.3336
	0.3335	0.3172
	0.3231	0.3008
ML0	0.3209	0.3281
	0.3341	0.3472
	0.3339	0.3336
	0.3219	0.3154

Group	Cx	Cy
MM0	0.3196	0.3451
	0.3345	0.3654
	0.3341	0.3472
	0.3209	0.3281
MN0	0.3183	0.3621
	0.3349	0.3830
	0.3345	0.3654
	0.3196	0.3451
NK0	0.3339	0.3336
	0.3465	0.3530
	0.3447	0.3347
	0.3335	0.3172
NL0	0.3341	0.3472
	0.3479	0.3673
	0.3465	0.3530
	0.3339	0.3336
NM0	0.3345	0.3654
	0.3498	0.3863
	0.3479	0.3673
	0.3341	0.3472
NN0	0.3349	0.3830
	0.3517	0.4053
	0.3498	0.3863
	0.3345	0.3654

Group	Cx	Cy
PK0	0.3465	0.3530
	0.3599	0.3735
	0.3567	0.3535
	0.3447	0.3347
PL0	0.3479	0.3673
	0.3623	0.3882
	0.3599	0.3735
	0.3465	0.3530
PM0	0.3498	0.3863
	0.3655	0.4079
	0.3623	0.3882
	0.3479	0.3673
PN0	0.3517	0.4053
	0.3687	0.4276
	0.3655	0.4079
	0.3498	0.3863

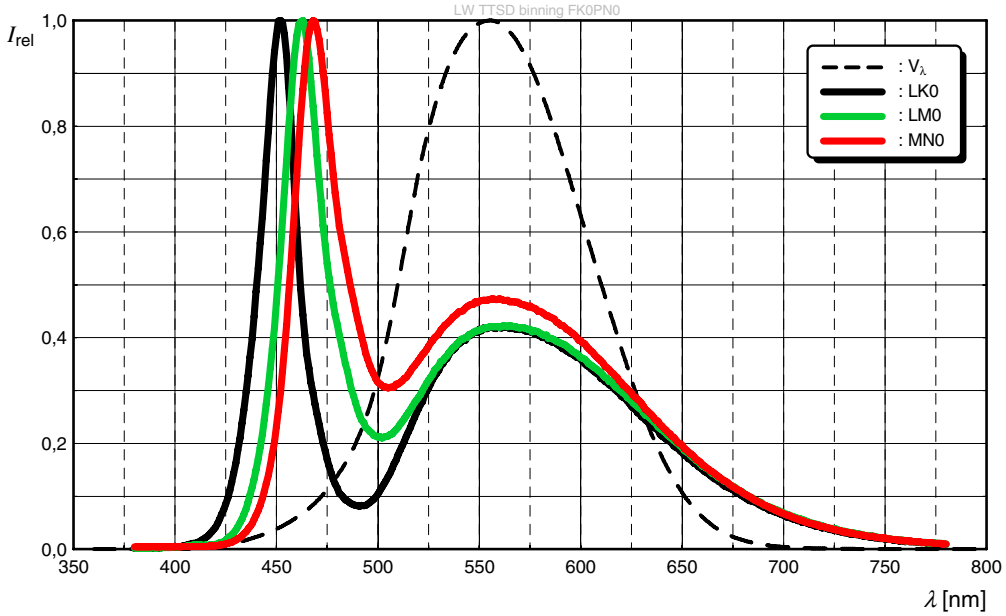
Group Name on Label

Example: U1-FK0-3

Brightness	Color Chromaticity	Forward Voltage
U1	FK0	3

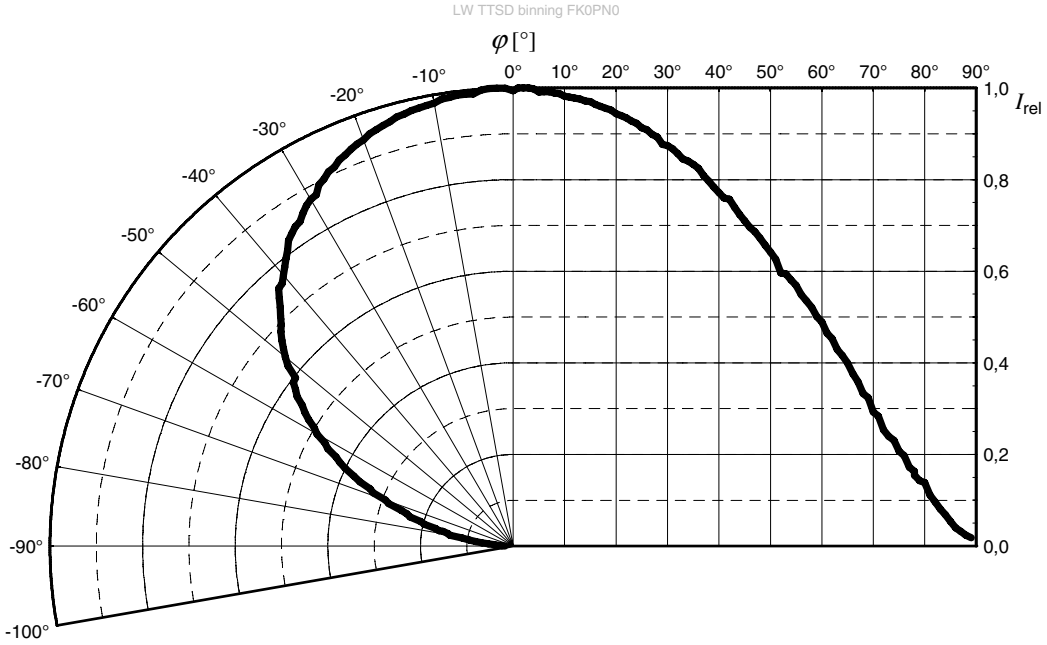
Relative Spectral Emission [7)]

$I_{rel} = f(\lambda)$; I_F = 20 mA; T_S = 25 °C



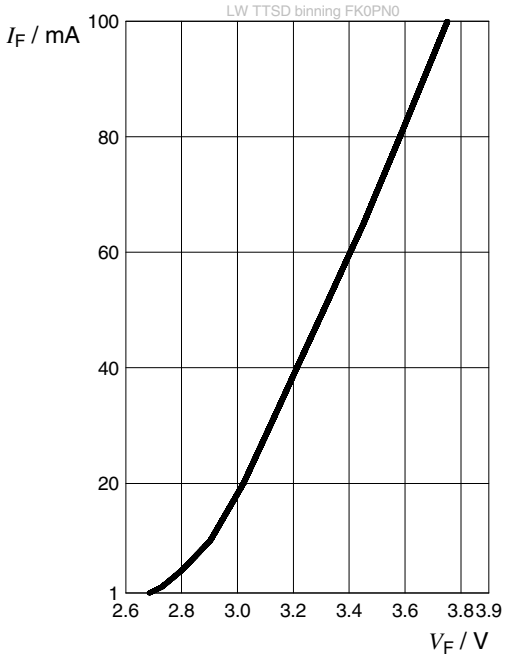
Radiation Characteristics [7)]

$I_{rel} = f(\phi)$; T_S = 25 °C



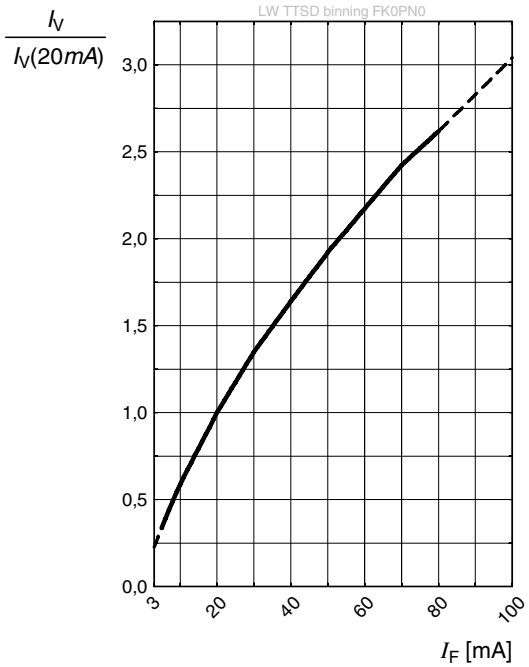
Forward current [7)]

$I_F = f(V_F)$; T_S = 25 °C



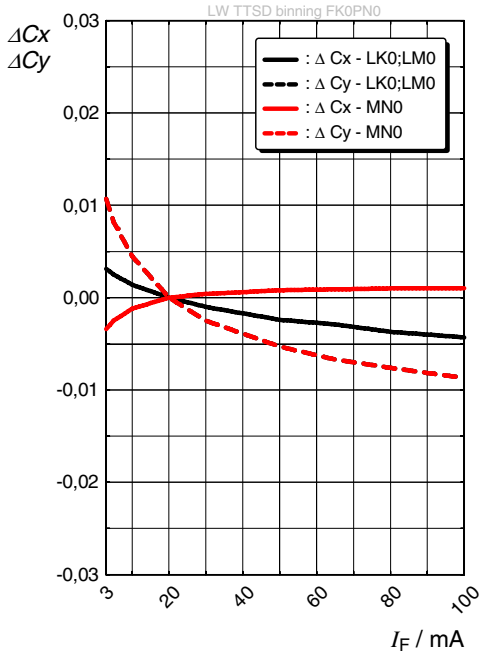
Relative Luminous Intensity [7), 8)]

$I_v/I_v(20\ mA) = f(I_F)$; T_S = 25 °C



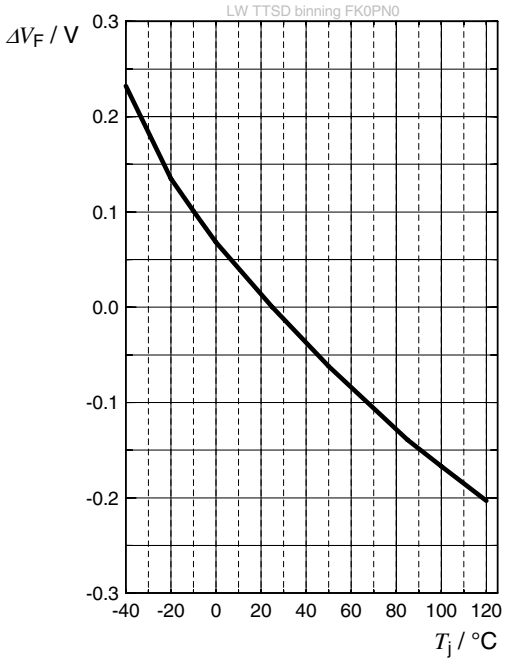
Chromaticity Coordinate Shift [7)]

ΔCx, ΔCy = $f(I_F)$; T_S = 25 °C



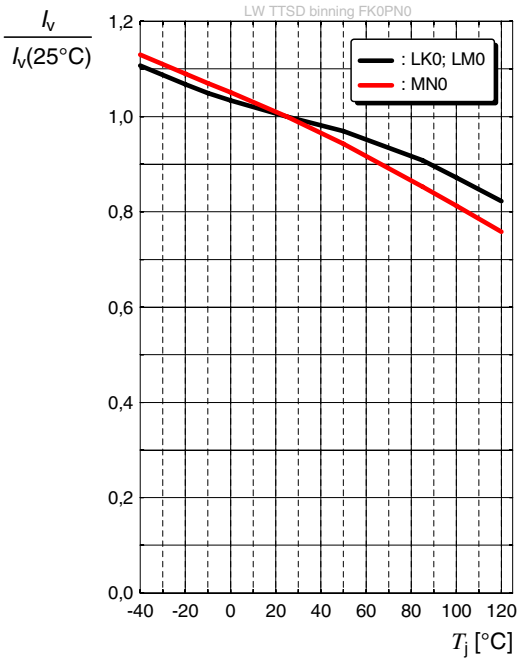
Forward Voltage 7)

$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 20\ mA$



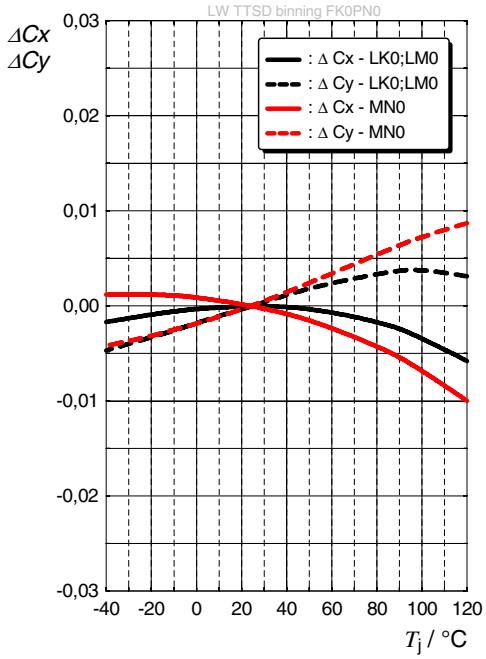
Relative Luminous Intensity 7)

$I_v/I_v(25\ °C) = f(T_j);\ I_F = 20\ mA$



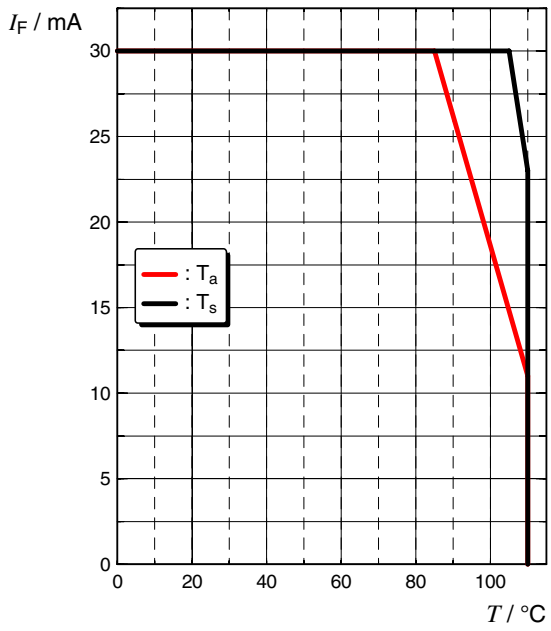
Chromaticity Coordinate Shift 7)

$\Delta Cx, \Delta Cy = f(T_j);\ I_F = 20\ mA$



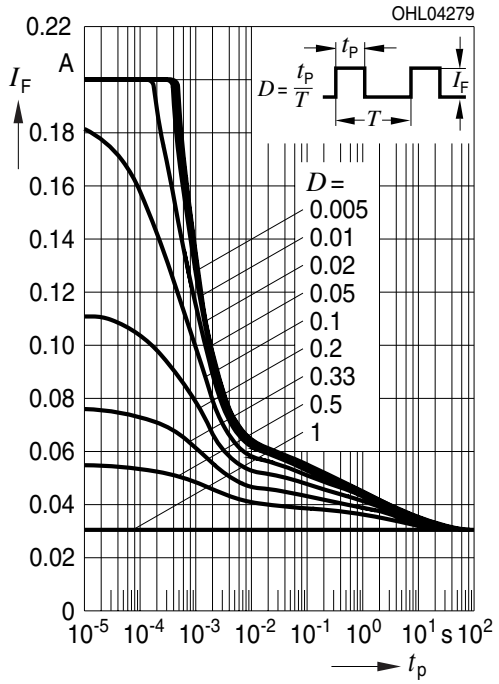
Max. Permissible Forward Current [5)]

$I_F = f(T)$



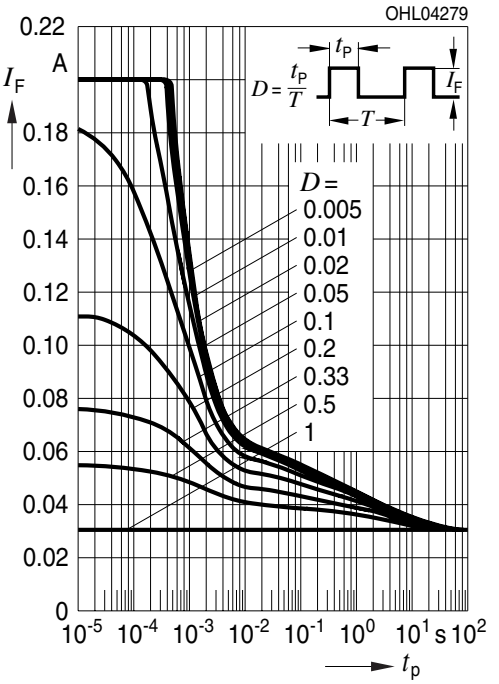
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; T_S = 25 °C

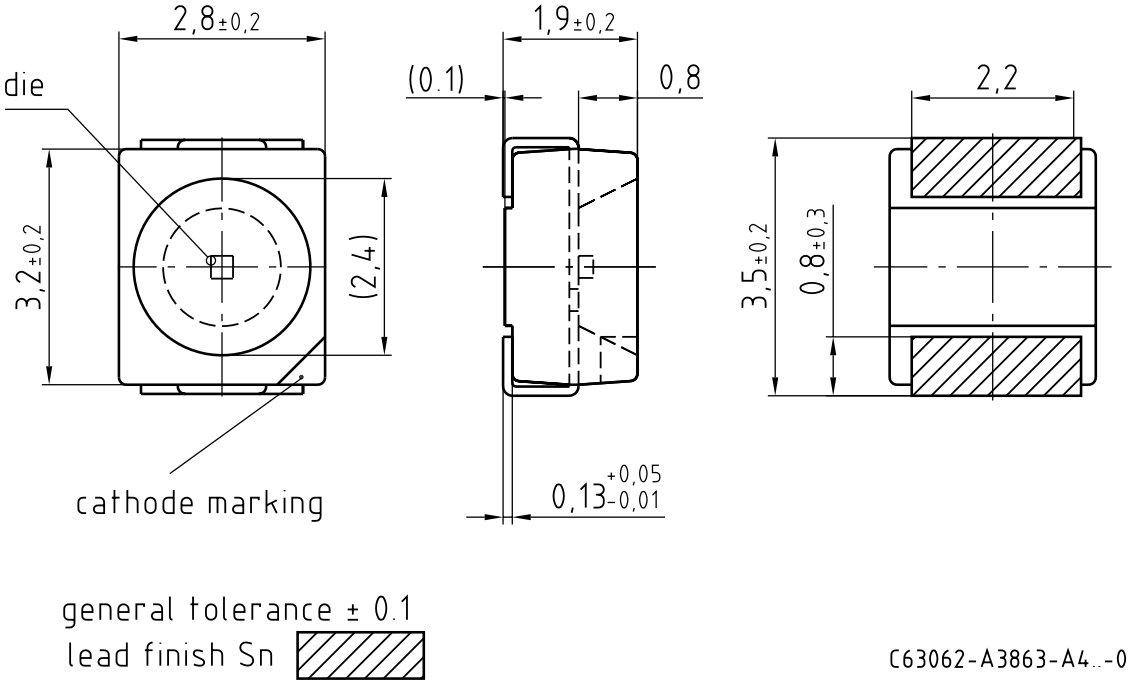


Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; T_S = 85 °C



Dimensional Drawing [9)]

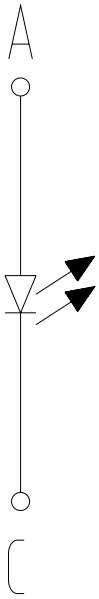


Further Information:

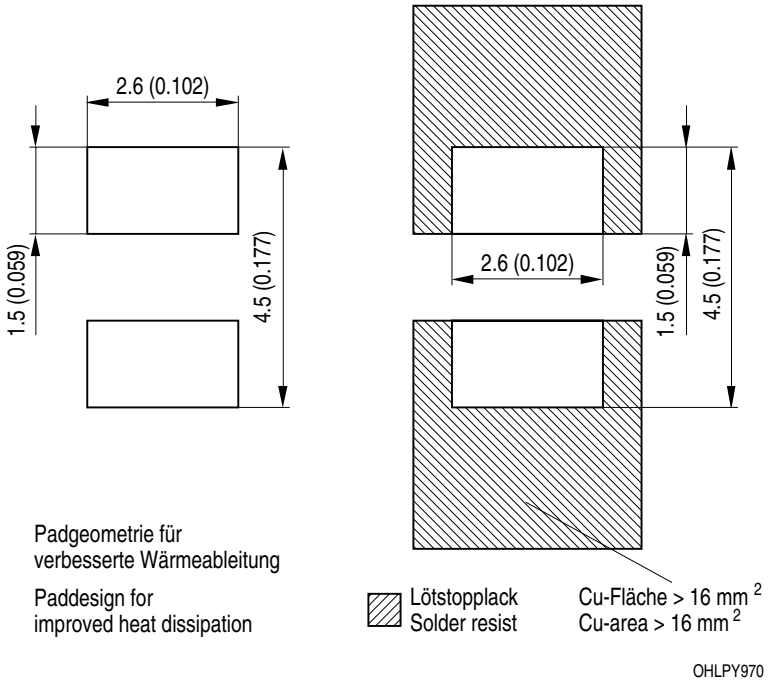
Approximate Weight: 32.0 mg

Corrosion test: Class: 3B
Test condition: 40°C / 90 % RH / 15 ppm H_2S / 14 days (stricter than IEC 60068-2-43)

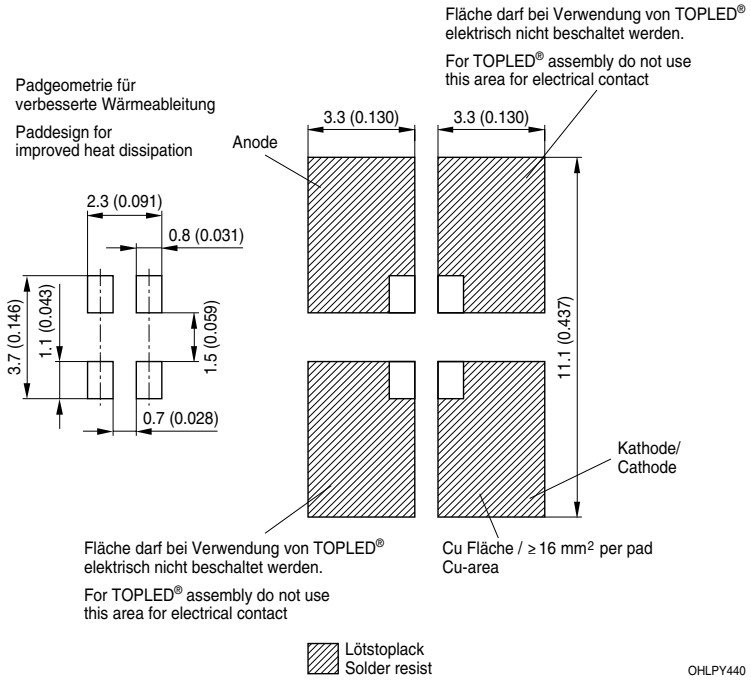
Electrical Internal Circuit



Recommended Solder Pad 9)



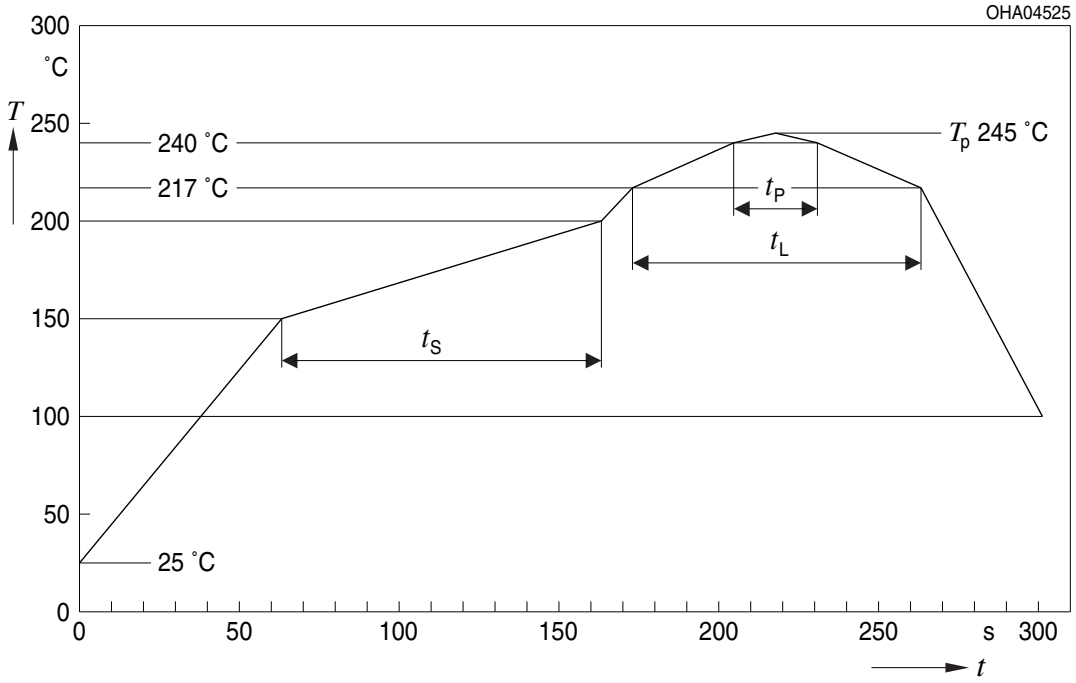
Recommended Solder Pad 9)



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

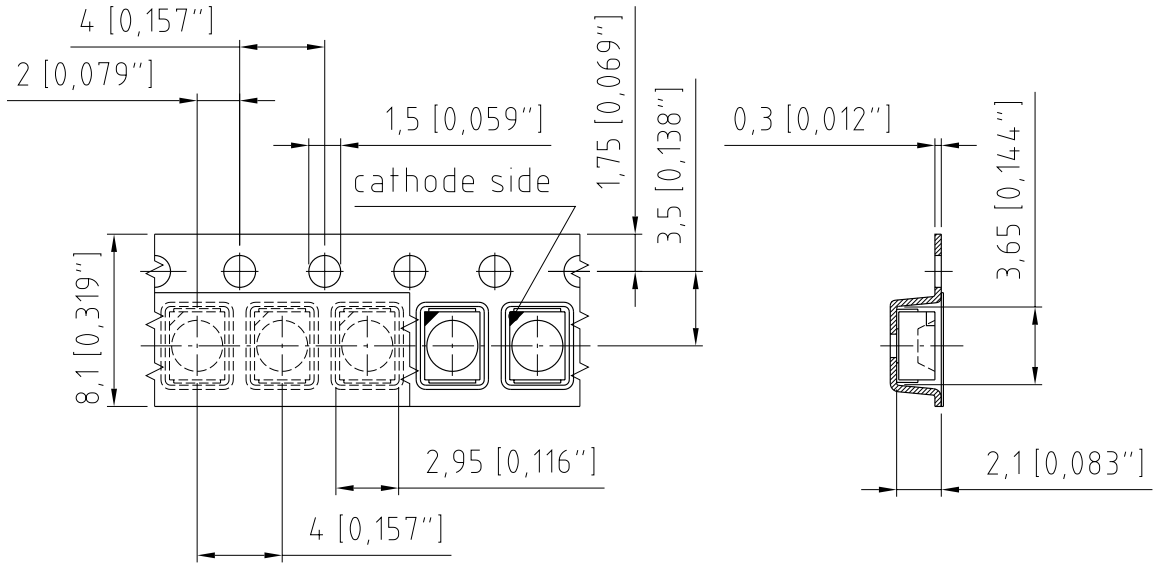
Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_P			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_P		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down rate* T_P to 100 °C			3	6	K/s
Time 25 °C to T_P				480	s

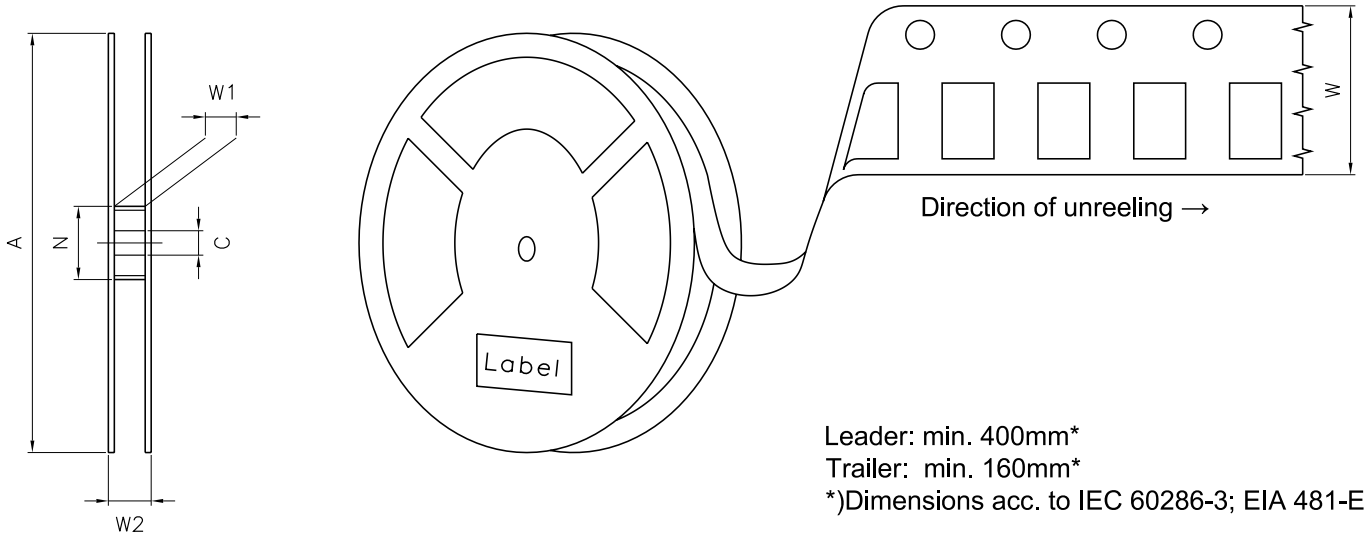
All temperatures refer to the center of the package, measured on the top of the component
* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Taping [9)]



C63062-A3863-B3 -02

Tape and Reel [10)]

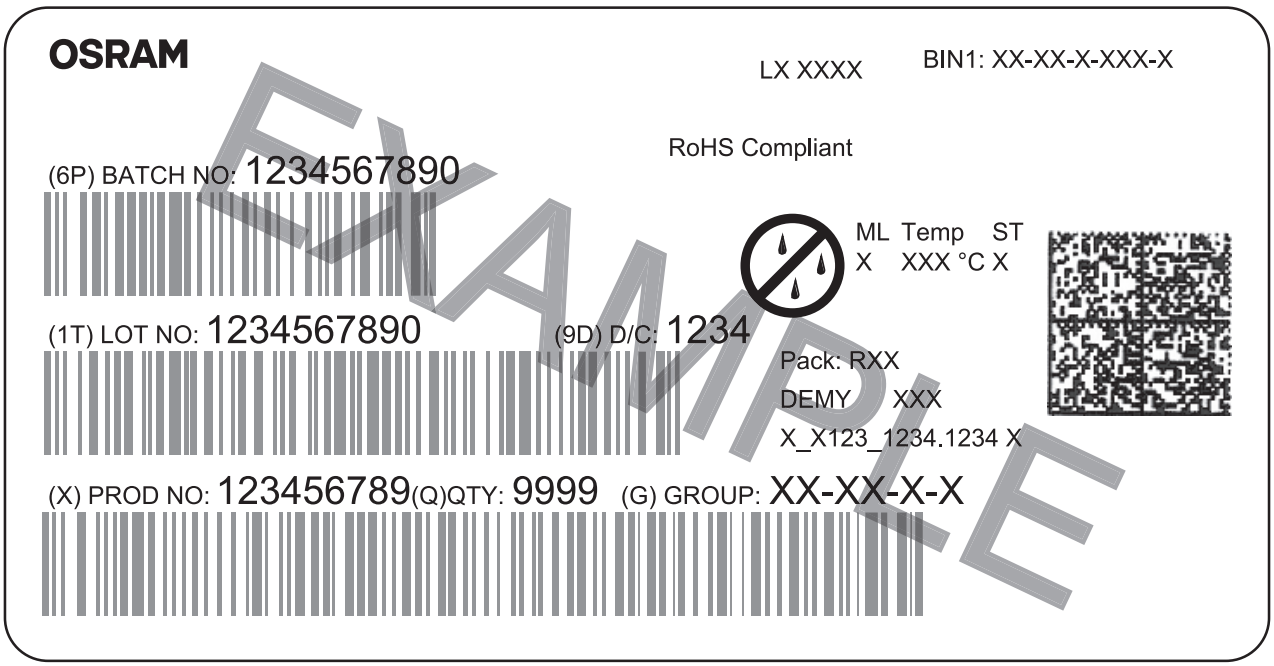


Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

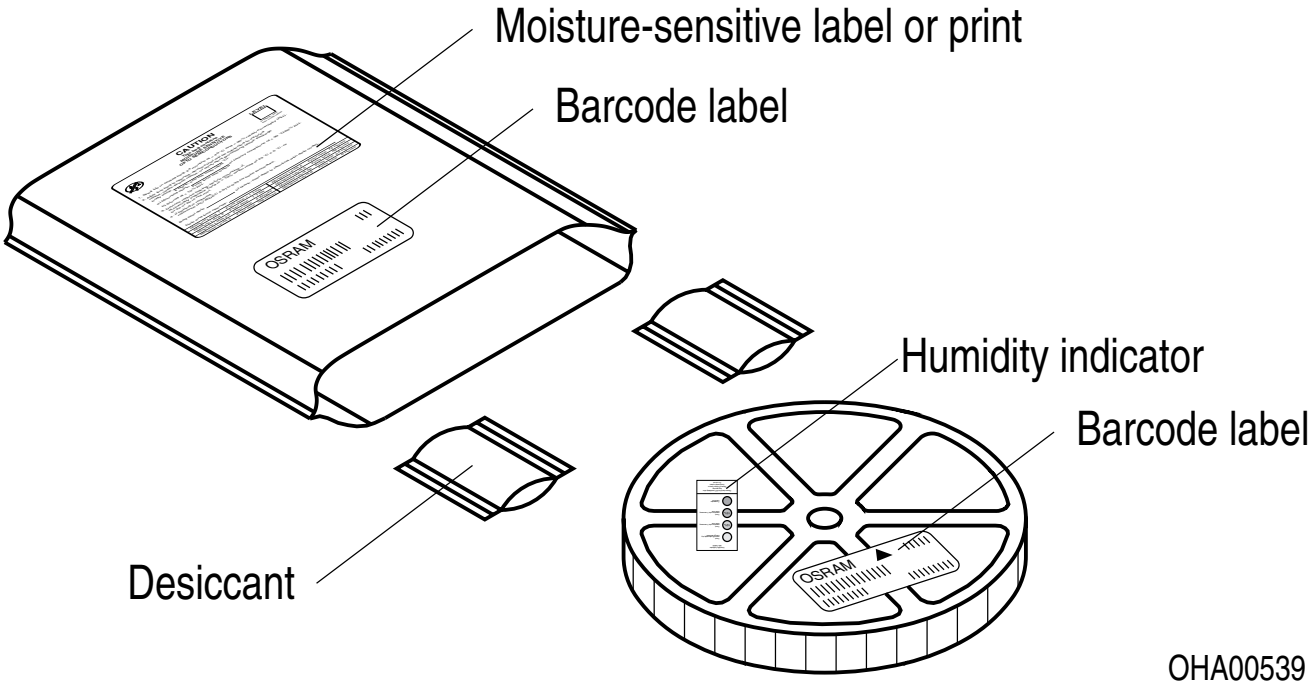
A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	2000
330 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	8000

Barcode-Product-Label (BPL)



OHA04563

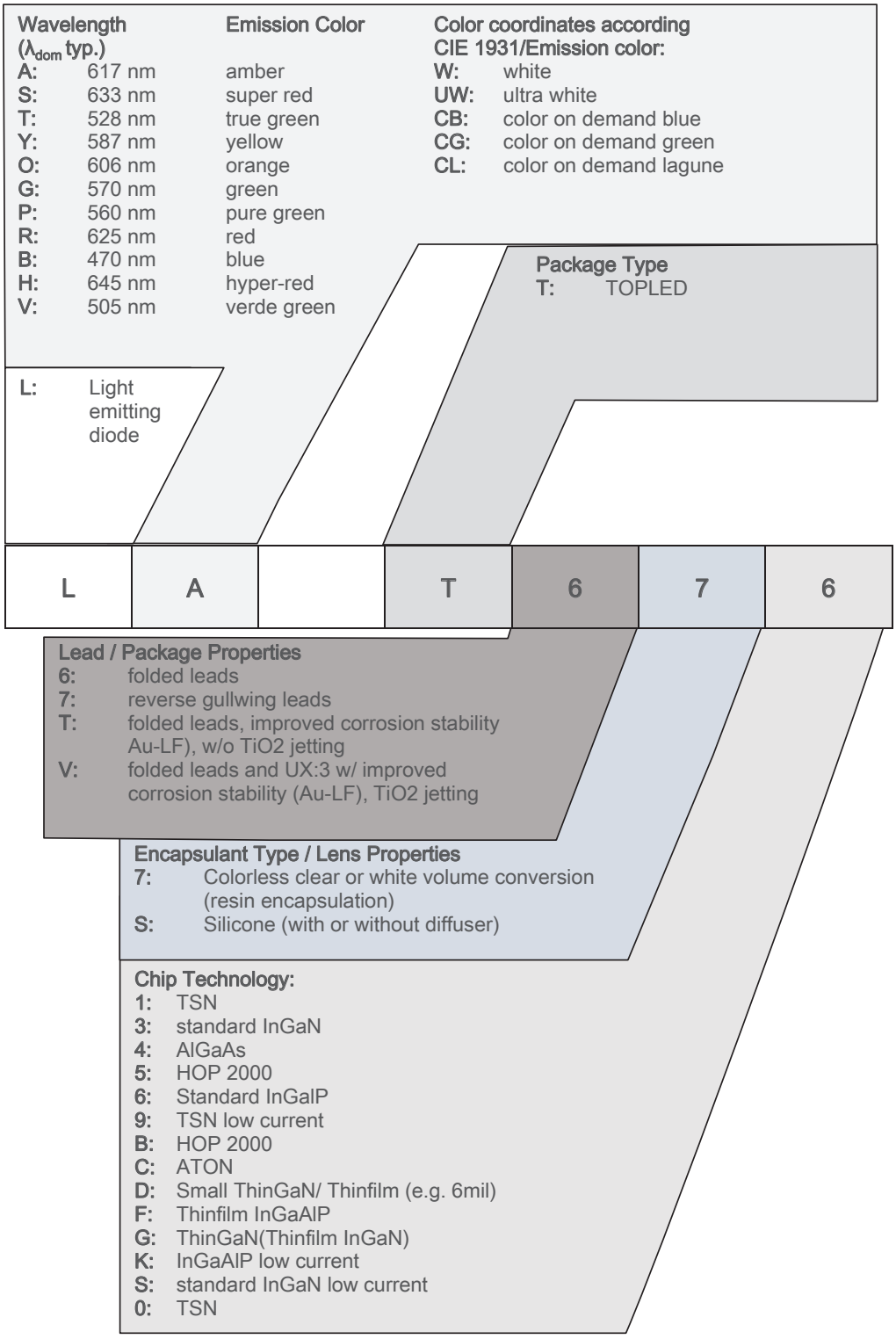
Dry Packing Process and Materials [9)]



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).

2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.

3) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±0.005 and an expanded uncertainty of ±0.01 (acc. to GUM with a coverage factor of k = 3).

4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).

5) **Thermal Resistance:** Rth max is based on statistic values (6σ) used for Derating.

6) **Thermal Resistance:** RthJA results from mounting on PC board FR 4 (pad size 16 mm² per pad)

7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.

9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.1	2019-09-06	Dimensional Drawing
1.2	2020-06-03	Ordering Information Forward Voltage Groups Electro - Optical Characteristics (Diagrams) Characteristics Glossary Dimensions of Transportation Box Schematic Transportation Box Electrical Internal Circuit
1.3	2022-11-07	New Layout Applications Derating (Diagrams)
1.4	2023-05-05	Electro - Optical Characteristics (Diagrams)

EU RoHS and China RoHS compliant product
此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

Published by ams-OSRAM AG
Tobelbader Strasse 30, 8141 Premstaetten, Austria
Phone +43 3136 500-0
ams-osram.com